

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China











### BAS21TM

## SURFACE MOUNT HIGH VOLTAGE SWITCHING DIODE ARRAY

### **Features**

- Fast Switching Speed: max. 50ns
- Continuous Reverse Voltage: max. 200V
- Repetitive Peak Reverse Voltage: max. 250V
- Repetitive Peak Forward Current: max. 1A
- Small Surface Mount Package
- For General Purpose Switching Applications
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: SOT26
- Case Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Copper Alloy leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 <a>®3</a>
- Orientation: See Diagram
- Weight: 0.009 grams (approximate)



Top View



Top View Internal Schematic

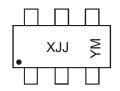
### Ordering Information (Notes 4)

Part Number	Compliance	Case	Packaging
BAS21TM-7	AEC-Q101	SOT26	3,000/Tape & Reel
BAS21TMQ-13	Automotive	SOT26	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



XJJ = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Z = 2012) M = Month (ex: 9 = September)

#### Date Code Key

Year	201	1 2	012	2013	2014	2018	5 2	016	2017	2018	2019	2020
Code	Y		Z	Α	В	С		D	Е	F	G	Н
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	$V_{RM}$	250	V	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	V <sub>RWM</sub> 250	
RMS Reverse Voltage		V <sub>R(RMS)</sub>	177	V
Forward Continuous Current (Note 5)		I <sub>FM</sub>	200	mA
Average Rectified Output Current (Note 5)		I <sub>0</sub>	250	mA
Non-Repetitive Peak Forward Surge Current	@ t = 10μs @ t = 100μs @ t = 10ms	I <sub>FSM</sub>	10 6 2	А

# **Thermal Characteristics**

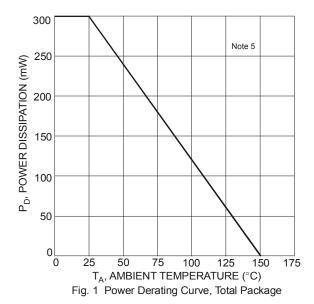
Characteristic	Symbol	Value	Unit	
Power Dissipation (Note 5)	$P_{D}$	300	mW	
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{ heta JA}$	417	°C/W	
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C	

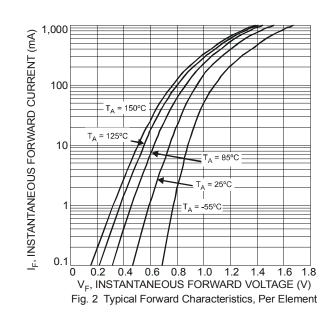
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V <sub>(BR)R</sub>	250	_	V	I <sub>R</sub> = 100μA
Forward Voltage	V <sub>F</sub>	_	1.0 1.25	V	I <sub>F</sub> = 100mA I <sub>F</sub> = 200mA
Reverse Current (Note 6)	I <sub>R</sub>	_	100 100	nΑ μΑ	V <sub>R</sub> = 200V V <sub>R</sub> = 200V, T <sub>J</sub> = +150°C
Total Capacitance	C <sub>T</sub>		5	pF	V <sub>R</sub> = 0, f = 1.0MHz
Reverse Recovery Time	t <sub>rr</sub>		50	ns	IF = IR = 30mA, $Irr = 0.1 \text{ x } IR, RL = 100\Omega$

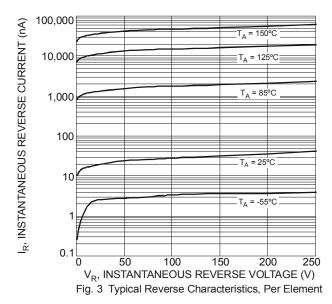
Note:

- 5. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- $\ensuremath{\text{6. Short duration pulse test used to minimize self-heating effect.}}$









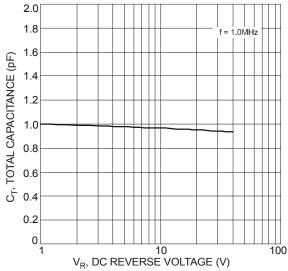
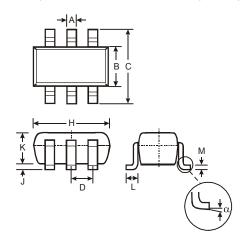


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

# **Package Outline Dimensions**

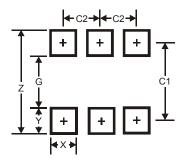
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT26						
Dim	Min	Max	Тур			
Α	0.35	0.50	0.38			
В	1.50	1.70	1.60			
O	2.70	3.00	2.80			
D	_	_	0.95			
Н	2.90	3.10	3.00			
J	0.013	0.10	0.05			
K	1.00	1.30	1.10			
L	0.35	0.55	0.40			
M	0.10	0.20	0.15			
α	0°	8°	_			
All Dimensions in mm						

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)		
Z	3.20		
G	1.60		
Х	0.55		
Υ	0.80		
C1	2.40		
C2	0.95		



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